

S. Stevenson
10-17-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/518,511
Priority Filing Date March 3, 2000
Inventor Dinesh Chopra, et al
Assignee Micron Technology, Inc.
Priority Group Art Unit 2825
Priority Examiner L. Malsawma
Attorney's Docket No. MI22-1747
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and
Integrated Circuits Formed Thereby

LETTER SUBMITTING FORMAL DRAWINGS

Assistant Commissioner for Patents
Attention: Official Draftsman
Washington, D.C. 20231

Please enter the enclosed formal drawings in the above-referenced application
in place of drawings originally filed.

Acknowledgment of receipt of the formal drawings and their acceptance into the
file is requested.

Respectfully submitted,

Date: 13 Jun 2001

By:

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Enclosures: Four (4) Sheets of Formal Drawings (Figs. 1-12)